Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (L²-π-MOSV)

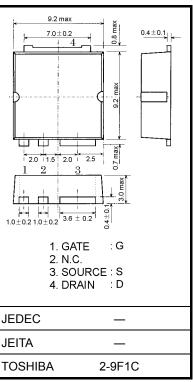
2SJ619

Switching Regulator and DC-DC Converter Applications Motor Drive Applications

- 4-V gate drive
- Low drain-source ON resistance: $R_{DS (ON)} = 0.15 \Omega (typ.)$
- High forward transfer admittance: $|Y_{fS}| = 7.7 \text{ S (typ.)}$
- Low leakage current: $I_{DSS} = -100 \mu A \text{ (max) (V}_{DS} = -100 \text{ V)}$
- Enhancement mode: $V_{th} = -0.8$ to -2.0 V ($V_{DS} = -10$ V, $I_D = -1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | | Symbol | Rating | Unit | |
|--|-------|----------|------------------|-----------|------|--|
| Drain-source voltage | | | V_{DSS} | -100 | V | |
| Drain-gate voltage ($R_{GS} = 20 \text{ k}\Omega$) | | | V_{DGR} | -100 | V | |
| Gate-source voltage | | | V _{GSS} | ±20 | V | |
| Drain current | DC | (Note 1) | I _D | -16 | А | |
| | Pulse | (Note 1) | I _{DP} | -64 | A | |
| Drain power dissipation (Tc = 25°C) | | | P_{D} | 75 | W | |
| Single pulse avalanche energy (Note 2) | | | E _{AS} | 292 | mJ | |
| Avalanche current | | | I _{AR} | -16 | Α | |
| Repetitive avalanche energy (Note 3) | | | E _{AR} | 7.5 | mJ | |
| Channel temperature | | | T _{ch} | 150 | °C | |
| Storage temperature range | | | T _{stg} | -55 to150 | °C | |



Weight: 0.74 g (typ.)

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Thermal Characteristics

| Characteristics | Symbol | Max | Unit | |
|-------------------------------------|------------------------|------|------|--|
| Thermal resistance, channel to case | R _{th (ch-c)} | 1.67 | °C/W | |

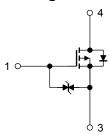
Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = -25 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 1.84 mH, $R_G = 25 \Omega$, $I_{AR} = -16 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

Circuit Configuration



2SJ619



Electrical Characteristics (Ta = 25°C)

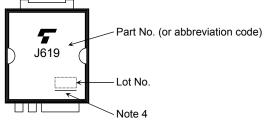
| Characteristics | | Symbol | Test Condition | Min | Тур. | Max | Unit | |
|--|---------------------------|----------------------|---|------|------|------|------|--|
| Gate leakage cur | ate leakage current | | $V_{GS} = \pm 16 \text{ V}, V_{DS} = 0 \text{ V}$ | _ | _ | ±10 | μА | |
| Drain cut-OFF cu | cut-OFF current | | $V_{DS} = -100 \text{ V}, V_{GS} = 0 \text{ V}$ | _ | _ | -100 | μА | |
| Drain-source brea | akdown voltage | V (BR) DSS | $I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$ | -100 | _ | _ | V | |
| Gate threshold vo | oltage | V _{th} | $V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$ | -0.8 | _ | -2.0 | V | |
| Drain-source ON resistance | | Pro (out) | $V_{GS} = -4 \text{ V}, I_D = -6 \text{ A}$ | _ | 0.25 | 0.32 | - Ω | |
| | | R _{DS} (ON) | $V_{GS} = -10 \text{ V}, I_D = -6 \text{ A}$ | | 0.15 | 0.21 | | |
| Forward transfer | rward transfer admittance | | $V_{DS} = -10 \text{ V}, I_D = -6 \text{ A}$ | 4.5 | 7.7 | _ | S | |
| Input capacitance | | C _{iss} | | _ | 1100 | _ | pF | |
| Reverse transfer capacitance | | C _{rss} | $V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | _ | 210 | _ | | |
| Output capacitance | | Coss | | _ | 440 | _ | | |
| Switching time | Rise time | t _r | Vos 0 V 7 | _ | 18 | _ | - ns | |
| | Turn-ON time | t _{on} | $V_{GS} = -8 \text{ A}$ $V_{GS} = -10 \text{ V}$ $C_{GS} = R_{L} = 6.25 \Omega$ | _ | 30 | _ | | |
| | Fall time | t _f | 95 | _ | 18 | _ | | |
| | Turn-OFF time | t _{off} | Duty ≦ 1%, t _W = 10 μs | _ | 65 | _ | | |
| Total gate charge (gate-source plus gate-drain) | | Qg | | _ | 48 | _ | | |
| Gate-source charge | | Q _{gs} | $V_{DD} \simeq -80 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -16 \text{ A}$ | _ | 29 | _ | nC | |
| Gate-drain ("miller") charge | | Q _{gd} | | _ | 19 | _ | | |

Source-Drain Ratings and Characteristics (Ta = 25°C)

| Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|---|------------------|---|-----|------|-----|------|
| Continuous drain reverse current (Note 1) | I _{DR} | _ | _ | _ | -16 | Α |
| Pulse drain reverse current (Note 1) | I _{DRP} | _ | _ | | -64 | Α |
| Forward voltage (diode) | V_{DSF} | I _{DR} = -16 A, V _{GS} = 0 V | _ | _ | 1.7 | V |
| Reverse recovery time | t _{rr} | $I_{DR} = -16 \text{ A}, V_{GS} = 0 \text{ V},$ | _ | 160 | | μS |
| Reverse recovery charge | Qrr | dI _{DR} /dt = 50 A/μs | _ | 0.5 | _ | μС |

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Marking

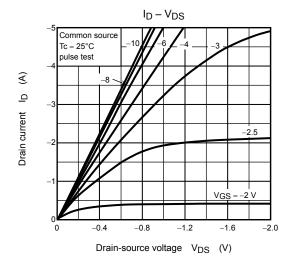


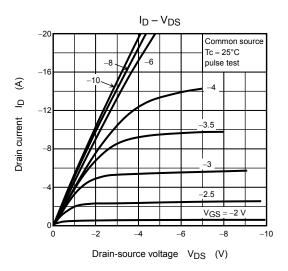
Note 4: A line under a Lot No. identifies the indication of product Labels.

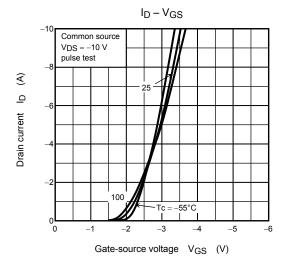
Not underlined: [[Pb]]/INCLUDES > MCV

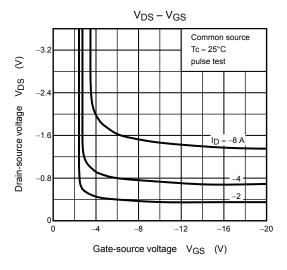
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

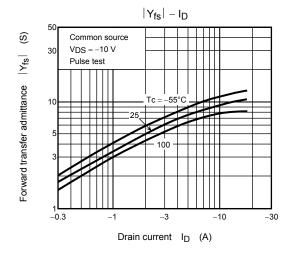
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

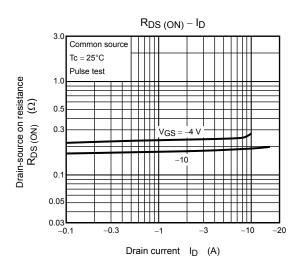


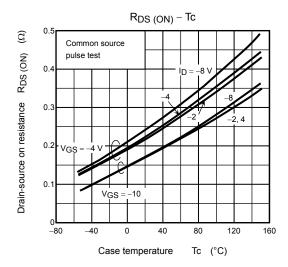


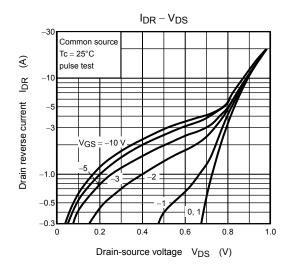


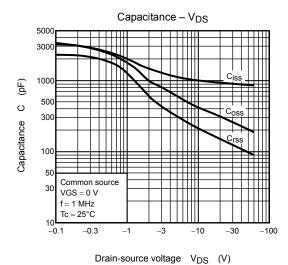


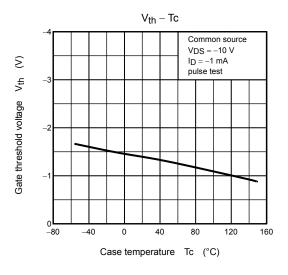


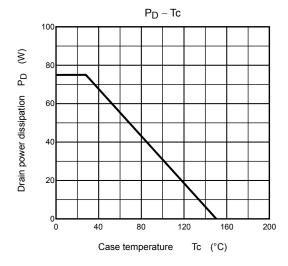


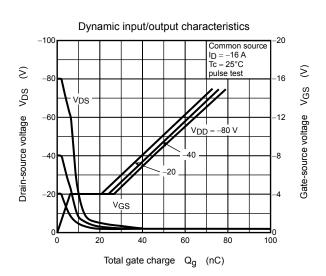


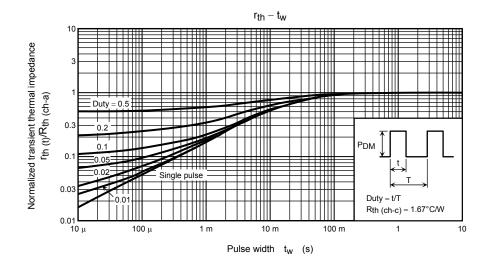


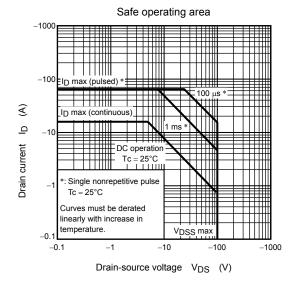


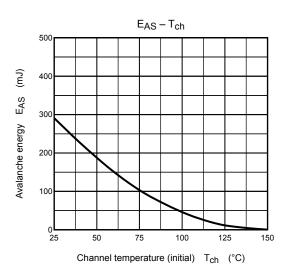


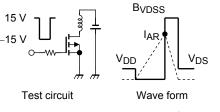












$$\begin{aligned} &R_G = 25~\Omega \\ &V_{DD} = -25~V,~L = 1.84~mH \end{aligned} \qquad \text{EAS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{\text{BVDSS}}{\text{BVDSS} - \text{VDD}} \right)$$

5 2009-09-29

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